Special Issue

3D Printing of MEMS Technology, Volume II

Message from the Guest Editor

3D printing is currently an emerging technology. While it was mostly used for rapid prototyping previously, this technology has long entered rapid production, especially for complicated objects or small lot sizes. Most recently, new 3D printing technologies have emerged that enable the smallest features, at the microor even nano-scale, to be printed. At the same time, well-known problems, such as the waviness of fused deposition modeling (FDM) printed parts, the missing long-term stability of some typical printing materials, or the reduced mechanical properties of 3D-printed objects, still exist. The first Special Issue focussing on 3D printing of MEMS technology contains studies on various 3D printing techniques, underlining the possibilities provided by recent technologies. We now welcome the most recent developments in this interdisciplinary research area for the second volume.

Guest Editor

Prof. Dr. Andrea Ehrmann

Faculty of Engineering and Mathematics, Bielefeld University of Applied Sciences and Arts, Interaktion 1, 33619 Bielefeld, Germany

Deadline for manuscript submissions

closed (31 January 2023)



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Micromachines
Editorial Office
MDPI, Grosspeteranlage 5
4052 Basel, Switzerland
Tel: +41 61 683 77 34
micromachines@mdpi.com

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Editor-in-Chief

Prof. Dr. Ai-Qun Liu

- 1. Department of Electrical and Electronic Engineering, The Hong Kong Polytechnic University, Hong Kong, China
- 2. School of Electrical and Electronic Engineering, Nanyang Technological University, Singapore 639798, Singapore

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